No.	LD-24455A
DATE	Apr. 27. 2012
REISION	

TECHNICAL LITERATURE

FOR

TFT - LCD module

# These parts have corresponded with the RoHS directive.

# MODEL No. LQ070Y3DG05

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DEPARTMENT DEPT. I DISPLAY DEVICE DIVISION II DISPLAY DEVICE DIVISION GROUP SHARP CORPORATION

# RECORDS OF REVISION

#### LQ070Y3DG05

SPEC No.	DATE		SUMMARY	NOTE
		PAGE		
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#### 1. Application

This technical literature applies to a color TFT-LCD module, LQ070Y3DG05

#### 2. Overview

This module is a color active matrix LCD module incorporating amorphous silicon TFT (Thin Film Transistor). It is composed of a color TFT-LCD panel, driver ICs, and a backlight unit.

Graphics and texts can be displayed on a 800×RGB×480 dots panel with 16,777,216 colors by using 24bit digital signal interface (RGB×8bit)and DC supply voltage for TFT-LCD panel driving and supply voltage for backlight.

In this TFT-LCD panel, low reflection / color filters of excellent color performance and backlights of high brightness are incorporated to realize brighter and clearer pictures, making this model optimum for use in multimedia applications.

Optimum viewing direction is 6 o'clock.

Backlight-driving DC/DC converter is built in this module.

3. Mechanical Specifications

Parameter	Specifications	Unit
Display size	17.6(7.0") Diagonal	cm
Active area	153.60(H)×86.64 (V)	mm
Disc. 1 Comm.	800 (H)×480 (V)	pixel
Pixel format	(1 pixel = R+G+B dots)	
Pixel pitch	0.192 (H)×0.1805 (V)	mm
Pixel configuration	R,G,B Vertical stripe	
Display mode	Normally white	
Surface treatment	Anti Glare and hard-coating 3H with EWV film	

Parameter		Min.	Тур.	Max.	Unit	Remark
	Width	164.7	165.0	165.3	mm	
Unit outline dimensions [Note 1]	Height	103.7	104.0	104.3	mm	[Note 1]
t	Depth		7.4	7.9	mm	
Mass		_	TBD	_	g	

[Note 1] Outline dimensions is shown in Fig.1,2

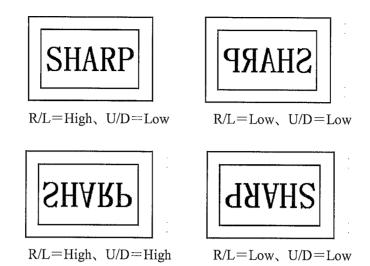
# 4. Input Terminals

4-1. TFT-LCD panel driving

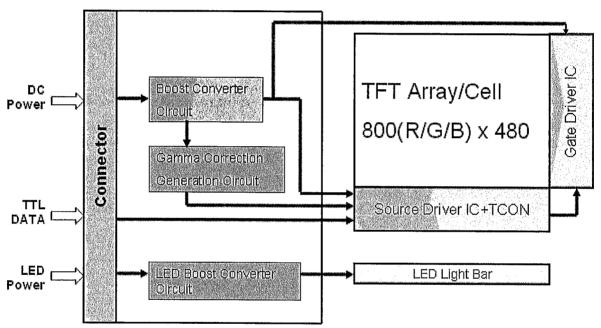
Pin No.	Symbol	Function	Remark
1	GND	Ground	
2	GND	Ground	
3	VDD	LCD Power Supply	
4	VDD	LCD Power Supply	
5	U/D	Vertical display mode select signal	[Note 4-3]
6	L/R	Horizontal display mode select signal	[Note 4-3]
7	GND	Ground	
8	R0	Red data input (LSB)	[Note 4-1]
9	R1	Red data input	[Note 4-1]
10	R2	Red data input	
11	R3	Red data input	
12	GND	Ground	
13	R4	Red data input	
14	R5	Red data input	
15	GND	Ground	
16	R6	Red data input	
17	R7	Red data input (MSB)	
18	GND	Ground	
19	G0	Green data input (LSB)	[Note 4-1]
20	G1	Green data input	[Note 4-1]
21	G2	Green data input	[11010 4-1]
22	G3	Green data input	
23	GND	Ground	
24	G4	Green Data input	
25	G5	Green data input	
26	GND	Ground	
27	G6	Green data input	
28	G7	Green data input (MSB)	
29	GND	Ground (WISB)	
30	B0	Blue data input (LSB)	FNT-4- 4 17
31	B1	Blue data input (LSB)	[Note 4-1]
32	B2	Blue data input	[Note 4-1]
33	B3	Blue data input	
34	GND	Ground	
35	B4	Blue data input	
36	B5	Blue data input	
37	GND	Ground	
38	B6	Blue data input	
39	B7	Blue data input (MSB)	
40	GND	Ground (WISB)	
41	DCLK	Clock signal for sampling each data signal	[NT-4- 4 07
42	GND	Ground Ground	[Note 4-2]
43	DE	Data Enable Signal	
44	TEST	Please fix "Low".	
45	GND	Ground	
46	GND	Ground	
47	LED PWM		
48		LED PWM Signal	TT! 1 70 44
49	LED EN	LED Enable Signal	High Enable
<del>1</del> 년 기	VLED VLED	LED Power  LED Power	

[Note 4-1] When input 18 bits RGB data, this terminals must be "Low" level.

[Note 4-2] Data shall be latch at falling edgh of DCLK.



# 4-2 Interface block diaglam



5. Absolute Maximum Ratings

D	G11	G 1171	Rat	ings		D 1
Parameter	Symbol	Condition	Min.	Max.	Unit	Remark
Input voltage	VDD		-0.3	4.0	V	[Note 3]
LED reverse voltage	VLED		-0.3	21	V	[Note 3]
T	VI1	Ta=25°C	-0.3	4.0	V	[Note 3,4]
Input voltage	VI2	Ta=25℃	-0.3	6.0	V	[Note 3,5]
Storage temperature	Tstg	-	-30	+80	$^{\circ}$	[Note 1,2,6]
Operating temperature	Topa	-	-20	+70	$^{\circ}$	[Note 1,2,6]

[Note 1] Humidity: 90%RH Max. (at Ta=<40°C)

Maximum wet-bulb temperature at 39°C or less (at Ta>40°C)

Dew condensation must be avoided as electrical current leaks will occur, causing a degradation of performance specifications.

[Note 2] The operating temperature guarantees only operation of the circuit.

For contrast, response time and other factors related to display quality, judgment is done using the ambient temperature Ta=+25°C.

[Note 3] Permanent damage may occur to the LCD module if beyond this specification. Functional operation should be restricted to the conditions described under normal operating conditions.

[Note 4] R0~R7, G0~G7, B0~B7, DCLK, DE, U/D, L/R, Do not use over VDD+0.3V.

[Note 5] LED PWM, LED EN, Do not use over VDD+0.3V.

[Note 6] Permanent damage may occur to the LCD module if beyond this specification.

Functional operation and LCD storage should be restricted to the conditions described under normal temperature (LCD outside).

#### 6. Electrical Characteristics

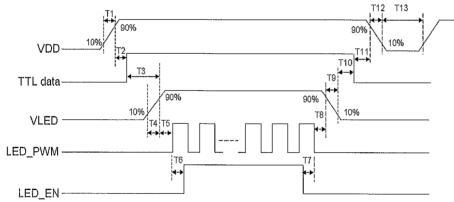
#### 6-1.TFT-LCD panel driving

Ta=25℃

	T	r	<del></del>		r <del></del>		
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit	Remark
Supply voltage	V <sub>DD</sub>		3.0	3.3	3.6	V	[Note 2]
Input voltage range	$I_{DD}$	V <sub>DD</sub> =3.3V		100	210	mA	Black pattern
Power consumption	$P_{DD}$		—		0.7	W	60Hz
Rush current	$I_{rush}$			_	1.5	A	[Note 3]
Permissive input ripple voltage	$V_{RP}$		_		100	$\mathrm{mV}_{ ext{P-P}}$	V <sub>DD</sub> =3.3V
Input voltage range	$V_{IH}$	"High"	$0.7V_{DD}$	-	$V_{DD}$	V	
Input voltage range	V <sub>IL</sub>	"Low"	0		$0.3V_{DD}$	V	[Note 1]
Input leak current	І <sub>ОН</sub>	V <sub>1</sub> =2.4V VDD=3.3V	_	—	400	μΑ	[Note 4]
Input leak current	$I_{OL}$	V <sub>12</sub> =0V	-10		+10	μΑ	,

[Note 1] R0 $\sim$ R7, G0 $\sim$ G7, B0 $\sim$ B7, DE, DCLK, L/R, U/D

# [Note 2]

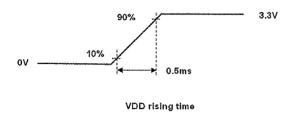


Symbol	Min.	Тур.	Max.	Unit
T1	0.5	-	10	ms
T2	30	-	90	ms
Т3	200	-	-	ms
T4	0.5	_	-	ms
T5	10	_	_	ms
Т6	10	-	-	ms
Т7	0	_	-	ms
Т8	10	-		ms
Т9	-	10	30	ms
T10	200	-	-	ms
T11	0	_	50	ms
T12	_	10	30	ms
T13	500	_	_	ms

<sup>\*</sup>TTL\_DATA: R0~R7, G0~G7, B0~B7, DE, DCLK, L/R, U/D

- ·This LCD is driven only by DE signal. Hsync/Vsync does not need to input.
- · As for the power sequence for backlight, it is recommended to apply above mentioned input timing. If the backlight is lit on and off at a timing other than shown above, displaying image may get disturbed.

#### [Note 3] LCD rush current measurement condition



#### [Note 4] VDD power dip condition

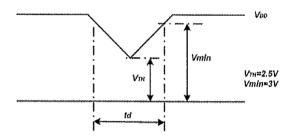
$$1) \ V_{th} < V_{CC} <= V_{min} \\ td <= 10 ms$$

Under above condition, the display image should return to an appropriate figure after Vcc voltage recovers.

2) 
$$V_{CC} < V_{th}$$

Vcc-dip conditions should also follow the

On-off conditions for supply voltage



#### 6-2.Backlight driving

It is usually required to measure under the following condition.

Ta=25°C±2°C

Parame	ter	Symbol	Min.	Тур.	Max.	Unit	Remarks
Supply voltage	<u> </u>	$V_{ m DD}$	4.5	12.0	16	V	[Note2] (see.page 7)
Power consum	otion	$I_{DD}$		-	2.1	W	
Permissive input ripple voltage		$V_{RP\_BL}$	-	<b></b>	200	mVp-p	
Input	High	$V_{\text{IH\_BL}}$	(3.0)	-	(5.5)		
voltage	Low	$V_{IL\_BL}$	0	_	(0.5)	V	[Note5]
Rush current		${ m I_{Lrush}}$	( )	3-4	(TBD)	mA	[Note8]
PWM frequence	су	$ m f_{PWM}$	(200)	-	(1,000)	Hz	Ddim>=5% [Note6]
Life time		LT	20000		-	Н	Reference value [Note7]

<u>VB</u>R

[Note 5] LED\_PWM、LED\_EN

[Note 6] PWM

fPWM = 1/t15

Duty 5%: Min. Luminance

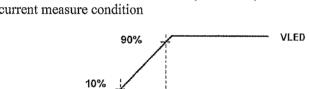
Duty 100%: Max. Luminance

Luminance changes in proportion to the duty ratio.

When the frequency slows, the display fineness might decrease.

[Note 7] Luminance becomes 50% of an initial value. (Ta=25°C, PWM=100%)

[Note 8] LED rush current measure condition



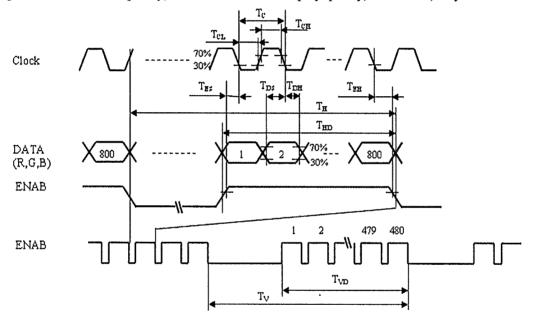
VLED rising time

# 7. Timing Characteristics of Input Signals

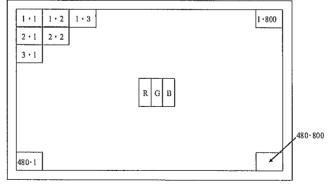
7-1. Timing characteristics

	Characteristic	S	Symbol	Min.	Тур.	Max.	Unit	Remark
DOTCLK	Frec	[uency	1/T <sub>C</sub>	28.0	30.0	35.0	MHz	
	High	Width	Tch	10	_	_	ns	
	Low	Width	Tc1	10	_		ns	
	Dut	y ratio	T <sub>CH</sub> /T <sub>C</sub>	40	50	60	%	
DATA	Setu	p Time	Tds	8	_	_	ns	
	Holo	l Time	Tdh	8	_	_	ns	
ENAB		Period	$T_{H}$	908	928	1080	clock	
	Horizontal	Display Area	$T_{HD}$	800	800	800	clock	
		Period	TV	517	525	704	line	[Note1]
		Display Area	TVp	480	480	480	line	
	Vertical	Setup time	$T_{ES}$	8	-	-	ns	
		Hold time	$T_{EH}$	8	-	-	ns	

[Note1] In case of lower frequency, the deterioration of display quality, flicker etc., may be occurred.



#### 7-2. Input data signals and display position on the screen



Display position of input data(V  $\cdot$  H)

8. Input Signals, Basic Display Colors and Gray Scale of Each Color

0, 1	որսւ ծւչ	znais,	Das	Basic Display Colors and Gray Scale of Each Color  Data signal																						
	Colors &	Gray							*				Data	sigi	ાલા	•	-									,
	Gray scale		R0	R1	R2	R3	R4	R5	R6	R7	G0	GI	G2	G3	G4	G5	G6	G7	В0	В1	B2	В3	B4	В5	В6	В7
	Black		0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Blue		0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	11	1
	Green		0	0	0	0	0	0	0	0	1	11	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	Cyan		0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Red		1	. 1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Magenta	_	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	1	1	1	1	1	11	1	1
	Yellow		1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	i	0	0	0	0	0	0	0	0
	White	_	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	l	1	1
	Black	GS0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
G	Û	GS1	_1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
гау (	Darker	GS2	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Scale	Û	<u> </u>	<b>.</b>								↓						ψ									
Gray Scale of Red	Û	Ψ	Ψ								↓					Ψ										
Red	Brighter	GS253	1	0	1	1	1	1	1	11	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	<u> </u>	GS254	0	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red	GS255	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Black	GS0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Grz	Û	GS1	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
ıy So	Darker	GS2	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0
ale	仓	<u> </u>				1								4	/				↓							
of G	Û	Ψ			·····	1		****						1	/							`	<u>١</u>	-1		
Gray Scale of Green	Brighter	GS253	0	0	0	0	0	0	0	0	1	0	1	1	1	1	11	1	0	0	0	0	0	0	0	0
	û	GS254	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	Green	GS255	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	Black	GS0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Gr	Û	GS1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0
Gray Scale of Blue	Darker	GS2	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0
cale	Û	<u> </u>	Ψ							$\downarrow$					İ				`	l						
of E	Û	Ψ	Ψ												<u> </u>											
3lue	Brighter	GS253	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	1	1	1	1	1	1
	Û	GS254	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1
	Blue	GS255	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1

<sup>0:</sup> Low level voltage,

Each basic color can be displayed in 256 gray scales from 8 bit data signals. According to the combination of total 24 bit data signals, the 16 million-color display can be achieved on the screen.

<sup>1:</sup> High level voltage.

# 9. Optical Characteristics

Ta=+25°C, Vcc=+3.3V

Parameter		Symbol	Condition	Min.	Тур.	Max.	Unit	Remark
Viewing angle range	Horizontal	$\theta$ 21, $\theta$ 22	CR>10	60	70		Deg.	100
	Vertical	θ 11		40	50	_	Deg.	[Note 1,3,6]
		θ 12		50	60		Deg.	
Contrast ratio		CRn	θ =0°	400	500	_		[Note 2,4,6]
Response time		τ r+ τ d		_	16	_	ms	[Note 2,5,6]
Chromaticity of white		х		0.260	0.310	0.360		[Note 2,6]
		у		0.280	0.330	0.380		
Luminance of white		YLI		280	350	_	cd/m <sup>2</sup>	[Note 2,6]

<sup>\*\*</sup> The measurement shall be executed 30 minutes after lighting at rating. Condition: Ddim=100% The optical characteristics shall be measured in a dark room or equivalent.

[Note 1] Measuring Viewing Angle Range

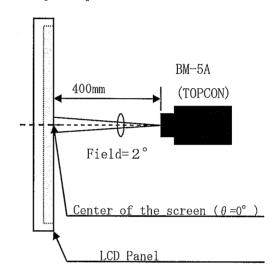
EZ contrast 160RH

(ELDIM)

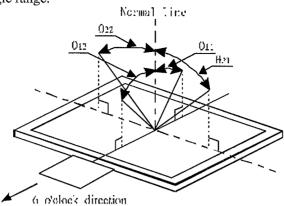
Center of the screen (θ =0°)

LCD Panel

[Note 2] Other Measurements



[Note 3] Definitions of viewing angle range:

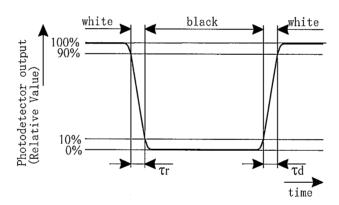


#### [Note 4] Definition of contrast ratio:

The contrast ratio is defined as the following.

#### [Note 5] Definition of response time:

The response time is defined as the following figure and shall be measured by switching the input signal for "black" and "white".



[Note 6] This shall be measured at center of the screen.

#### 10. Display Quality

The display quality of the color TFT-LCD module shall be in compliance with the Incoming Inspection Standard.

11. Handling Precautions

	dling Precautions						
Handl	ing Precautions						
a )	Treat LCD module in dustless surroundings. Metal foreign material stuck to the circuit is possible to						
	cause a short.						
b)	Be sure to design the cabinet so that the module can be installed without any extra stress such as warp or twist.						
c)	Be careful not to give any physical stress onto the circuit and/or the connector of LCD module						
·	when you pull/plug a cable. Physical stress will cause a break or worse connection.						
<u>d)</u>	Since the front polarizer is easily damaged, pay attention not to scratch it.						
e )	Use N2-blower such as an ionized nitrogen has anti-electrostatic when you blow dusts on Polarizer.						
f)	Since a long contact with water may cause discoloration or spots, wipe it with absorbent cotton or other soft cloth immediately.						
g)	Since CMOS LSI is used in this module, take care of static electricity and injure the human earth when handling. Observe all other precautionary requirements in handling components.						
h )	Be careful with the edge parts of the module which is made of metal.						
11 )	Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.						
i)	Handle with care.						
j)	When the panel is broken, don't touch the glass. Although the panel is difficult to be scattered, touching the broken part may hurt your hands.						
k)	Liquid crystal contained in the panel may leak if the LCD is broken. Rinse it as soon as possible						
~ <i>)</i>	if it gets inside your eye or mouth by mistake.						
1)	Don't touch the circuit and the pattern of the board. If you touch it, the circuit may be broken.						
	Follow the regulations when LCD module is scrapped. The government you stay may have some						
m)	regulations about it.						
	Protection film is attached to the module surface to prevent it from being scratched .Peel the film off slowly,						
n)	just before the use, with strict attention to electrostatic charges. Blow off 'dust' on the polarizer by using						
11 )	an ionized nitrogen.						
o)	After peel off the protection filme, do not attach a lamination etc on thr polarizer surface.						
	If reattach a lamination film and strage a long terms,						
Set-D	esion Precantions]						
	Notice: Never take to pieces the module, because it will come failure						
a )	Notice: Never take to pieces the module, because it will cause failure.						
	Notice: Never take to pieces the module, because it will cause failure.  Be sure to design the cabinet so that the module can be installed without any extra stress such as warp or twist.						
a )	Notice: Never take to pieces the module, because it will cause failure.						
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Opera	ation Precautions
a)	Do not expose the LCD panel to direct sunlight. Lightproof shade etc. should be attached when LCD panel is used under such environment.
b)	When handling LCD modules and assembling them into cabinets, please avoid that long-terms storage in the environment of oxidization or deoxidization gas and the use of such materials as reagent, solvent, adhesive, resin, etc. which generate these gasses, may cause corrosion and discoloration of the modules. Do not use the LCD module under such environment.
c)	An abnormal display by changing in quality of the polarizing plate might occur regardless of contact or no contact to the polarizing plate, because of epoxy resin (amine system curing agent) that comes out from the material and the packaging material used for the set side, the silicon adhesive (dealcoholization system and oxime system), and the tray blowing agents (azo-compound), etc. Please confirm adaptability with your employed material.
d)	Don't use polychloroprene (CR) with LCD module. It will generate chlorine gas, which will damage the reliability of the connection part on LCD panel.
e)	Be careful when using it for long time with fixed pattern display as it may cause accidential image.  Pleave use a screen saver etc., in order to avoid an afterimage.
f)	The LED (Light Emitting Diode) used in this LCD module is very sensitive to temperature change. If it operates for extremely long time under high temperature, it is possible rapidly to shorten the life time of LED. In case of such a condition, consult with us.
g)	If stored at the temperatures lower than the rated storage temperature, the LC may freeze and it may cause LCD panel damage. If storage temperature exceeds the specified rating, the molecular orientation of the LC may change to that of a liquid, and they may not revert to their original state. Store the module in normal room temperature.
h)	Keep LCD module in the range of the specified temperature conditions at all times. Once out of the range, liquid crystal will lose its characteristics, and it cannot recover.
i)	Nature of dew consideration prevention is necessary when LCD is used for long time under high-temperatur and high-humidity.

12. Packing form

Product countries	(TBD)		
Piling number of cartons	(TBD)		
Package quantity in one carton	(TBD)		
Carton size	(TBD)		
Total mass of one carton filled with full modules	(TBD)		
Packing form is shown	(TBD)		

# 13. RoHS Directive

This LCD module is compliant with RoHS Directive.

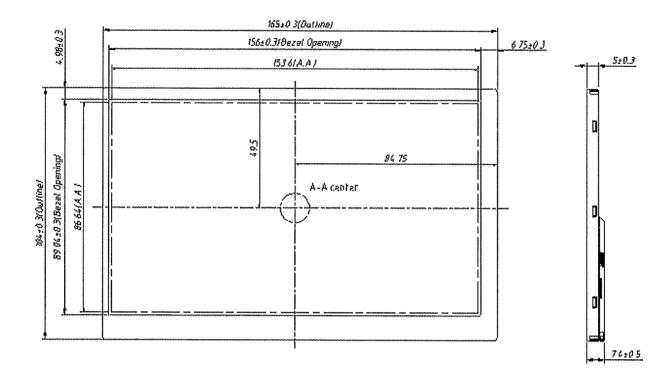


Fig.1 Outline Dimensions(Front Side)

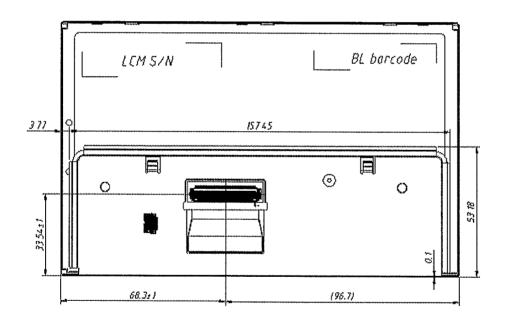


Fig.2 Outline Dimensions(Back Side)